

JN3 Product Description

80403ST10104A Rev.0 - 2012-01-19



Making machines talk.



APPLICABILITY TABLE





Reproduction forbidden without written authorization from Telit Communications S.p.A. - All Rights Reserved. Mod. 0808 2011-07 Rev.2 Page 2 of 38



SPECIFICATIONS SUBJECT TO CHANGE WITHOUT NOTICE

Notice

While reasonable efforts have been made to assure the accuracy of this document, Telit assumes no liability resulting from any inaccuracies or omissions in this document, or from use of the information obtained herein. The information in this document has been carefully checked and is believed to be entirely reliable. However, no responsibility is assumed for inaccuracies or omissions. Telit reserves the right to make changes to any products described herein and reserves the right to revise this document and to make changes from time to time in content hereof with no obligation to notify any person of revisions or changes. Telit does not assume any liability arising out of the application or use of any product, software, or circuit described herein; neither does it convey license under its patent rights or the rights of others.

It is possible that this publication may contain references to, or information about Telit products (machines and programs), programming, or services that are not announced in your country. Such references or information must not be construed to mean that Telit intends to announce such Telit products, programming, or services in your country.

Copyrights

This instruction manual and the Telit products described in this instruction manual may be, include or describe copyrighted Telit material, such as computer programs stored in semiconductor memories or other media. Laws in the Italy and other countries preserve for Telit and its licensors certain exclusive rights for copyrighted material, including the exclusive right to copy, reproduce in any form, distribute and make derivative works of the copyrighted material. Accordingly, any copyrighted material of Telit and its licensors contained herein or in the Telit products described in this instruction manual may not be copied, reproduced, distributed, merged or modified in any manner without the express written permission of Telit. Furthermore, the purchase of Telit products shall not be deemed to grant either directly or by implication, estoppel, or otherwise, any license under the copyrights, patents or patent applications of Telit, as arises by operation of law in the sale of a product.

Computer Software Copyrights

The Telit and 3rd Party supplied Software (SW) products described in this instruction manual may include copyrighted Telit and other 3rd Party supplied computer programs stored in semiconductor memories or other media. Laws in the Italy and other countries preserve for Telit and other 3rd Party supplied SW certain exclusive rights for copyrighted computer programs, including the exclusive right to copy or reproduce in any form the copyrighted computer program. Accordingly, any copyrighted Telit or other 3rd Party supplied SW computer programs contained in the Telit products described in this instruction manual may not be copied (reverse engineered) or reproduced in any manner without the express written permission of Telit or the 3rd Party SW supplier. Furthermore, the purchase of Telit products shall not be deemed to grant either directly or by implication, estoppel, or otherwise, any license under the copyrights, patents or patent applications of Telit or other 3rd Party supplied SW, except for the normal non-exclusive, royalty free license to use that arises by operation of law in the sale of a product.



Page 3 of 38



Usage and Disclosure Restrictions

License Agreements

The software described in this document is the property of Telit and its licensors. It is furnished by express license agreement only and may be used only in accordance with the terms of such an agreement.

Copyrighted Materials

Software and documentation are copyrighted materials. Making unauthorized copies is prohibited by law. No part of the software or documentation may be reproduced, transmitted, transcribed, stored in a retrieval system, or translated into any language or computer language, in any form or by any means, without prior written permission of Telit

High Risk Materials

Components, units, or third-party products used in the product described herein are NOT fault-tolerant and are NOT designed, manufactured, or intended for use as on-line control equipment in the following hazardous environments requiring fail-safe controls: the operation of Nuclear Facilities, Aircraft Navigation or Aircraft Communication Systems, Air Traffic Control, Life Support, or Weapons Systems (High Risk Activities"). Telit and its supplier(s) specifically disclaim any expressed or implied warranty of fitness for such High Risk Activities.

Trademarks

TELIT and the Stylized T Logo are registered in Trademark Office. All other product or service names are the property of their respective owners.

Copyright © Telit Communications S.p.A. 2012.



Page 4 of 38



Contents

1. Int	roduction	8
1.1.	Scope	8
1.2.	Audience	8
1.3.	Contact Information, Support	8
1.4.	Document Organization	8
1.5.	Text Conventions	9
1.6.	Related Documents	9
2. Ge	noval Product Description	10
2. Ge	neral Product Description	10
3. Teo	chnical Description	11
3.1.	Product Compatibility	11
3.2.	Receiver Architecture	12
3.3.	Major Components	12
3.3.	1. GSD4e Chip	
3.3.	_	
3.3.	_	
3.3.		
3.3.		
3.3. 3.3.		
3.3. 3.3.		
3.3.		
3.3.		
3.4.	Physical Characteristics	
3.5.	Mechanical Specification	
3.6.	External Antenna Connection	
3.7.	Input/Output and Power Connections	15
3.8.	Environmental	
3.9.	Compliances	
3.10.	Marking/Serialization	
3.11.	Active Antenna Gain Requirements	
	•	
	formance Characteristics	
4.1.	TTFF (Time to First Fix)	

69 0

Page 5 of 38



	4.1.		
	4.1.2		
4	.2.	AGPS	
	.3.	Time Mark Pulse (1PPS)	
	.4.	Power Management	
	4.4.	-	
4.	.5.	Differential Aiding	19
	4.5.	e	
4.	.6.	Performance Data	20
4.	.7.	Dynamic Constraints	21
5.	Ele	ctrical Requirements	22
5.	.1.	Power Supply	22
	5.1.	1. VCC_IN	22
	5.1.2	2. VBATT	
5.	.2.	External Antenna Voltage	22
5.	.3.	RF (Radio Frequency) Input	22
5.	.4.	Antenna Gain	
5.	.5.	Burnout Protection	22
5.	.6.	Jamming Performance	22
5.	.7.	Flash Upgradability (Flash only)	24
5.	.8.	Patch Updates (EEPROM only)	24
5.	.9.	Data Input/Output Specifications	24
	5.9.	1. Voltages and Currents	
	5.9.2		
	5.9.3	3. Pinout Description	
6.	Soft	tware Interface	27
6.	.1.	NMEA Output Messages	27
6.	.2.	SiRF OSP Output Messages	27
6.	.3.	Software Functions and Capabilities	
7.	Me	chanical Drawing	29
8.	Eva	aluation Kit	31



Page 6 of 38



9. P	roduct Handling	32
9.1.	Product Packaging and Delivery	
9.2.	Moisture Sensitivity	
9.3.	ESD Sensitivity	
9.4.	Safety	
9.5.	Disposal	
10.	Ordering Information	34
11.	Glossary and Acronyms	35
12.	Safety Recommendations	
13.	Document History	





1. Introduction

1.1. Scope

Scope of this document is to give an overview of new standalone GPS module JN3.

1.2. Audience

This document is intended for customers developing applications using JN3.

1.3. Contact Information, Support

For general contact, technical support, to report documentation errors and to order manuals, contact Telit Technical Support Center (TTSC) at:

TS-EMEA@telit.com TS-NORTHAMERICA@telit.com TS-LATINAMERICA@telit.com TS-APAC@telit.com

Alternatively, use:

http://www.telit.com/en/products/technical-support-center/contact.php

For detailed information about where you can buy the Telit modules or for recommendations on accessories and components visit:

http://www.telit.com

To register for product news and announcements or for product questions contact Telit Technical Support Center (TTSC).

Our aim is to make this guide as helpful as possible. Keep us informed of your comments and suggestions for improvements.

Telit appreciates feedback from the users of our information.

1.4. Document Organization

This document contains the following chapters:



Reproduction forbidden without written authorization from Telit Communications S.p.A. - All Rights Reserved. Mod. 0808 2011-07 Rev.2



<u>"Chapter 1: "Introduction"</u> provides a scope for this document, target audience, contact and support information, and text conventions.

"Chapter 2: "General Description" gives an overview of the features of the product.

"Chapter 3: "Technical Description" describes the features of the product.

<u>"Chapter 4: "Performance Characteristics"</u> describes in details the characteristics of the product.

<u>"Chapter 5: "Electrical Requirements"</u> describes in details the electrical characteristics of the product.

<u>"Chapter 6: "Software Interface"</u> provides some fundamental hints about the conformity assessment that the final application might need.

"Chapter 7: "Mechanical Drawings" provides info about Hardware interfaces.

"Chapter 8: "Evaluation Kit" provides some fundamental hints about evaluation Kit.

"Chapter 9: "Product Handling" describes the packaging and mounting of the module.

"Chapter 10: "Glossary and acronyms" contain the explanation of acronyms used in the present document

<u>"Chapter 11: "Safety Recommendation"</u> provides some safety recommendations that must be follow by the customer in the design of the application that makes use of the JN3.

"Chapter 12: "Document History" provides the history of the present document.

1.5. Text Conventions



<u>Danger – This information MUST be followed or catastrophic equipment failure or bodily</u> <u>injury may occur.</u>



Caution or Warning – Alerts the user to important points about integrating the module, if these points are not followed, the module and end user equipment may fail or malfunction.



Tip or Information – Provides advice and suggestions that may be useful when integrating the module.

All dates are in ISO 8601 format, i.e. YYYY-MM-DD.

1.6. Related Documents

- JN3 Hardware User Guide,
- JN3 EVK User Guide,



Reproduction forbidden without written authorization from Telit Communications S.p.A. - All Rights Reserved. Mod. 0808 2011-07 Rev.2 Page 9 of 38



2. General Product Description

Building upon the SiRFstarIVTM architecture's high-performance, the JN3 device incorporate innovations such as SiRFawareTM, SiRFInstantFixTM and Active Jammer Removal. TheJN3 can navigate to -160dBm and track to -163dBm, providing higher coverage, accuracy and availability. This next generation Jupiter Module consumes only 13mA (3.3V) in 1-Hz TricklePowerTM mode. The JN3 offers A-GPS support and operate with a 3.3V power supply. JN3 supports a full range of satellite-based augmentation systems, including WAAS, EGNOS, MSAS and GAGAN.

The GPS module combines the SiRFstarIV[™] GSD4e[™] GPS engine, TCXO, SAW filter, RTC, LDO, level conversion and memory (Flash and EEPROM devices only).



Page 10 of 38



3. Technical Description

High-speed Location Engine – Twice the available DSP memory and search speed of SiRFstarIII architecture for enhanced sensitivity and navigation performance, greater coverage, reduced time to fix and improved positional accuracy.

Battery Backup is supported via a separate pin for applications that use a battery backup source.

Smart Sensor Interface – Sensor support improves the location experience, enables greater context awareness, and opens the door to superior indoor positioning accuracy. This is achieved via the I2C port and a 3 axis accelerometer.

Active Jammer Remover – Advanced DSP technology actively identifies and removes jammers prior to correlation. This feature maximizes GPS performance and helps identify issues during the design phase. Up to 8 jammers can be identified and removed.

- Removes in-band jammers up to 80 dB-Hz
- Tracks up to 8 CW jammers

High Performance Solution:

- High sensitivity navigation engine (PVT) tracks as low as -163dBm
- 48 track verification channels
- SBAS (WAAS), EGNOS, MSAS, GAGAN

Advanced Navigation Features:

- Smart sensor I2C interface
- · Interrupt input for context change detection

3.1. Product Compatibility

The JN3 incorporates a new technology far advanced compared to the previous SiRFstarIII designs. It offers an upgrade path from existing Telit and competitive designs.

NMEA version 3.0 protocol is supported as well as the new SiRF ONE SOCKET binary PROTOCOL (OSP).



Page 11 of 38



3.2. Receiver Architecture

The functional architecture of the JN3 receiver is shown in Figure 1. **Note:** The LNA is included in the GPS chip for passive antenna operation.

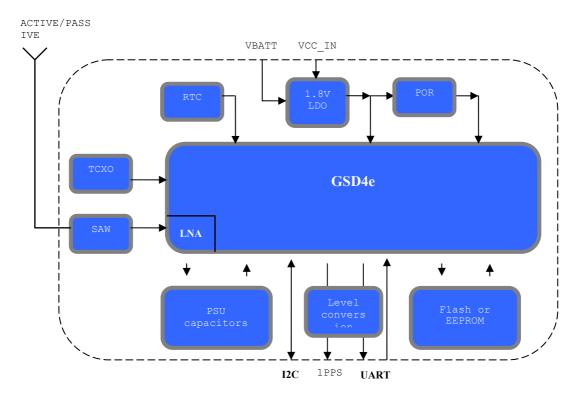


Figure 1 – JN3 Architecture

Note: LNA is included in the GPS chip for passive antenna operation.

3.3. Major Components

All power supply components are on board including capacitors.

3.3.1. GSD4e Chip

This single chip GPS device includes an integrated Baseband and RF sections. The LNA amplifies the GPS signal and provides enough gain for the receiver to use a passive antenna. A very low noise design is utilized to provide maximum sensitivity. This LNA is internal to the GPS baseband and can be switched between low and high gain mode.





3.3.2. **RF_IN**

GPS RF signal input. This requires an external BIAS-T and antenna voltage supply for active antenna.

3.3.3. VCC_IN

This is the primary 2.85V to 3.6V supply voltage for the module. A voltage of 2.85V to 3.3V is recommended.

3.3.4. VBATT

The Battery Backup supply voltage is 2.2V to 3.3V. A typical low current supply for ensuring the RTC/BBRAM is kept running to ensure HOT/WARM starts. Higher battery backup supply voltages are catered for up to 3.6V.

3.3.5. Host Port

The JN3 has a single serial communications port -- UART. See the Designer's Notes for more details.

3.3.6. MEMS Sensor Interface

The DR I2C port is used for MEMS sensor interface. Reference the Designer's Notes for more details on how to connect to an accelerometer and/or magnetic sensor to this port.

3.3.7. SAW Filter (1.575 GHz)

This filters the GPS signal and removes unwanted signals caused by external influences that would corrupt the operation of the receiver. The filtered signal is fed to the RF input of GSD4e chipset for further processing.

3.3.8. TCXO

This highly stable 16.369 MHz oscillator controls the down conversion process for the RF block.

3.3.9. RTC

The Real Time Clock allows Hot/Warm starts and low power modes.

3.3.10. Memory

The JN3 Flash design includes a 16MB Flash storage device for operational software and satellite data.

The JN3 EEPROM design includes a 512KB EEPROM storage device for patch code and satellite data.

The JN3 ROM-only design does not include on-module memory. External Host memory may be used to store patch code and satellite data.





3.4. Physical Characteristics

The JN3 receiver has advanced miniature packaging with a base metal of copper and an Electroless Nickel Immersion Gold (ENIG) finish.

It has 24 interface pads. These are castellated edge contacts.





3.5. Mechanical Specification

The physical dimensions of the JN3 are as follows:

- length: $16.0 \text{ mm} \pm 0.1 \text{ mm}$
- width: $12.2 \text{ mm} \pm 0.1 \text{ mm}$
- thickness: 2.4 mm \pm 0.2 mm
- weight: 1 g max

Refer to Figure 2 for the JN3 mechanical layout drawing.

3.6. External Antenna Connection

The RF connection for the external antenna has a characteristic impedance of 50 ohms.

3.7. Input/Output and Power Connections

The I/O (Input / Output) and power connections use surface mount pads.

3.8. Environmental

The environmental operating conditions of the JN3 are as follows:

- temperature: -40° C to $+85^{\circ}$ C (measured on the shield)
- humidity: up to 95% non-condensing or a wet bulb temperature of +35°C
- shock (non-operating): 18 G peak, 5 ms

3.9. Compliances

The JN3 complies with the following:

- Directive 2002/95/EC on the restriction of the use of certain hazardous substances in electrical and electronic equipment (RoHS)
- Manufactured in an ISO 9000: 2000 accredited facility
- Manufactured to TS 16949 requirement (upon request)

3.10. Marking/Serialization

The JN3 supports a 2D barcode indicating the unit serial number below. The Telit 13-character serial number convention is:

- characters 1 and 2: year of manufacture (e.g. 10 = 2010, 11 = 2011)
- characters 3 and 4: week of manufacture (01 to 52, starting first week in January)
- character 5: manufacturer code
- characters 6 and 7: product and type



Page 15 of 38



- character 8: product revision
- characters 9-13: sequential serial number





3.11. Active Antenna Gain Requirements

LNA Gain Setting	LNA Gain (dB)	GPS Noise Figure (dB)	Recommended External Gain Range (dB)
Low	6.0 - 10.0	8.5 - 9.5	16-30
High (default)	16.0 - 20.0	4.0	8-18

Table 1 – Active Antenna Gain Requirements

Notes:

- 1. Recommended external gain range is total any external gain, such as antenna or external LNA and any passive loss due to cables, connectors, filters, matching network, etc.
- 2. In the High Gain setting an external LNA is not recommended.
- 3. In the Low Gain setting, the noise figure of the external LNA or active antenna must be chosen to ensure that the total cascaded noise figure is sufficiently low to meet overall system design requirements.





Page 18 of 38

4. **Performance Characteristics**

4.1. TTFF (Time to First Fix)

TTFF is the actual time required by a GPS receiver to achieve a valid position solution. This specification will vary with the operating state of the receiver, the length of time since the last position fix, the location of the last fix, and the specific receiver design.

4.1.1. Hot Start

A hot start results from a software reset after a period of continuous navigation, or a return from a short idle period (i.e. a few minutes) that was preceded by a period of continuous navigation. In this state, all of the critical data (position, velocity, time, and satellite ephemeris) is valid to the specified accuracy and available in memory.

4.1.2. Warm Start

A warm start typically results from user-supplied position and time initialization data or continuous RTC operation with an accurate last known position available in memory. In this state, position and time data are present and valid but ephemeris data validity has expired.

4.1.3. Cold Start

A cold start acquisition results when either position or time data is unknown. Almanac information is used to identify previously healthy satellites.

Please refer to section 3.6 for performance data.





4.2. AGPS

GPS aiding comes in several forms. For the purposes of this document, we will focus on extended ephemeris data as a form of assisted GPS data.

InstantFix (SGEE and CGEE) is a method of GPS aiding that effectively reduces the TTFF by making every start a Hot or Warm start, through the use of ephemeris predictions.

CGEE captures ephemeris data from satellites locally and predicts ephemeris up to 3 days.

SGEE does not require local ephemeris collection from satellites; it receives the extended ephemeris data from a server.

The module supports AGPS as standard. TELIT provides a server for customers to download the SGEE file. Contact TELIT for support regarding this service.

Note: Due to memory size constraints, the EEPROM devices do not support SGEE.

Note: The ROM-only devices do not support CGEE or SGEE. External Host memory can be used to enable both these features. See Designer's Notes for more details on how to interface with external Host memory.

4.3. Time Mark Pulse (1PPS)

A 1PPS time mark pulse is provided as an output with a width of 200ms. This signal has not been verified or characterized for all operational conditions.

Note: The GPS receiver will only provide 1PPS when a 3D fix has been obtained using 5 SVs. When the fix degrades below a 3D solution, the 1PPS will be blanked. Once the fix quality improves back to a 3D fix the 1PPS will again be output.

4.4. **Power Management**

The following paragraph describes the power management mode supported by the JN3.

4.4.1. Adaptive Trickle Power (ATP)

Trickle Power mode is a duty-cycled power management mode that reduces average current consumption by the JN3 while retaining a high quality of GPS accuracy and dynamic motion response. The duty cycle and navigation update rate are specified by the user to best fit in the operating environment. This mode adapts to weak or blocked satellite signals by transitioning the JN3 in and out of full power mode as needed in order to maintain GPS performance.

4.5. Differential Aiding

4.5.1. Satellite Based Augmentation Systems (SBAS)

The JN3 is capable of receiving WAAS, EGNOS, MSAS, and GAGAN differential corrections which are regional implementations of SBAS. SBAS improves horizontal position accuracy by correcting GPS signal errors caused by ionospheric disturbances, timing and satellite orbit errors.



Reproduction forbidden without written authorization from Telit Communications S.p.A. - All Rights Reserved. Mod. 0808 2011-07 Rev.2 Page 19 of 38



Parameter	Description		F	Performance	
	Description	Min	Typical	Max	Units
Horizontal Position Accuracy ¹	Autonomous	-	<2.5	-	m
Velocity	Speed	-	-	< 0.01	m/s
Accuracy ²	Heading	-	-	< 0.01	0
	Hot Start: Autonomous	-	<1	-	S
	Warm Start: Autonomous	-	<35	-	S
Time to	Cold Start: Autonomous	-	<35	-	S
First Fix ³	MS Based: GSM coarse time	-	<4.7	-	s
	MS Assisted: GSM coarse time	-	<4.7	-	s
	Autonomous acquisition	-147		-	dBm
Sensitivity	GSM/UMTS ⁴ coarse time aided	-160	-	-	dBm
	CDMA ⁴ precise time aided	-160	-	-	dBm
	Tracking	-163	-	-	dBm
	Navigation	-160	-	-	dBm

4.6. **Performance Data**

50%, 24 hr static, -130 dBm

50% @ 30 m/s

50%, -130 dBm (Fu 0.5 ppm, Tu ±2 s, Pu 30 Km)

Supported on JN3 Flash designs only. Not available in standard code release.

Table 2 – JN3 Performance Data





4.7. Dynamic Constraints

The JN3 receiver will lose track if any of the following limits are exceeded:

- ITAR limits: velocity greater than 514 m/s AND altitude above 18,288 m
- altitude: 24,000 m (max) or -500 m (min)
- velocity: 600 m/s (max)
- acceleration: 4 G (max)
- vehicle jerk: $5 \text{ m/s}^3 \text{ (max)}$





5. Electrical Requirements

5.1. **Power Supply**

5.1.1. VCC_IN

Main 2.85V-3.6V power input. Reference the Designer's Notes for additional details.

Supply voltage: 2.85V to 3.6V +/- 30mV noise/ripple.

5.1.2. VBATT

Battery backup power input. 2.2V to 3.3V recommend. Maximum 3.6V supported, minimum of 2.2V. Required for HOT/WARM starts and retention of GPS data.

5.2. External Antenna Voltage

The JN3 requires an external antenna Bias-T to provide the voltage to the antenna. This is detailed in the Designer's Notes.

5.3. RF (Radio Frequency) Input

RF input is 1575.42 MHz (L1 Band) at a level between –135 dBm and –165 dBm into 50 Ohm impedance.

5.4. Antenna Gain

The receiver will operate with a passive antenna with Isotropic gain down to a minimum of - 6dBi. Active antennas are supported. The internal LNA must be switched to low gain mode if an active antenna is used.

An active antenna of 20dB minimum (exiting the cable) will offer the best performance. 30dB exiting the antenna cable is maximum useable active antenna gain. Refer to section 2.11 for more details.

Contact TELIT for in depth passive antenna design support.

5.5. Burnout Protection

The receiver accepts without risk of damage a signal of +10 dBm from 0 to 2 GHz carrier frequency, except in band 1560 to 1590 MHz where the maximum level is -10 dBm.

5.6. Jamming Performance

Eight separate in band jammers can be detected and digitally removed in the GPS DSP. This is over and above the excellent SAW filter response that exists before the GPS LNA input.

Note: The spectral purity of oscillators and RF transmitters in the host system will determine if harmonics are formed that are equal to the frequencies above.



Reproduction forbidden without written authorization from Telit Communications S.p.A. - All Rights Reserved. Mod. 0808 2011-07 Rev.2 Page 22 of 38



Compact wireless product design requires close monitoring of jamming issues.



Reproduction forbidden without written authorization from Telit Communications S.p.A. - All Rights Reserved. Mod. 0808 2011-07 Rev.2 Page 23 of 38



5.7. Flash Upgradability (Flash only)

The firmware programmed in the Flash memory may be upgraded via the serial port TX/RX pads. The user can control this by driving the Serial BOOT select line high at startup, then downloading the code from a PC with suitable software (SiRFFlash). In normal operation this pad should be left floating for minimal current drain. It is recommended that in the user's application, the BOOT select pad is connected to a test pad for use in future software upgrades. Refer to the Designer's Notes for additional information.

5.8. Patch Updates (EEPROM only)

Modules with EEPROM can be patched from the Host using simple One Socket Protocol (OSP) Patch Protocol serial messages. Patches are stored inside the I2C Serial EEPROM and are automatically applied by internal firmware whenever the baseband CPU is started.

Note: ROM-only devices can support patch updates, if Host memory is available.

5.9. **Data Input/Output Specifications**

All communications between the JN3 receiver and external devices are through the I/O surface mount pads. These provide the contacts for power, ground, serial I/O and control. Power requirements are discussed in the following sections.

Parameter	Symbol	Min	Тур	Max	Unit
Power Supply Voltage ¹	VCC_IN	2.85	2.9 to 3.3	3.6	V
Operating Temperature ²	T _{OPR}	-40		85	⁰ C
Current Consumption ³ :					
Acquisition			41		mA
Tracking			32		mA
Battery Backup Supply	VBATT	2.2	3	3.6	V
Battery Backup Current:					
Flash modules			40		uA
EEPROM modules			122		uA
Trickle Power Current			10		mA

5.9.1. **Voltages and Currents**

Operating temperature is ambient. LNA set to High Gain Mode.

Table 3 – Power Requirements



Reproduction forbidden without written authorization from Telit Communications S.p.A. - All Rights Reserved. Mod. 0808 2011-07 Rev.2

Page 24 of 38



Units

V

V

V

		aximum Katings	
Parameter	Symbol	Rating	
Power Supply Voltage	VCC IN	3.6	

Absolute Maximum Ratings

Storage Temperature	T _{stg}	-40°C to +85°C	^{0}C	
Storage remperature	- stg		č	
Warning – Stressing the device beyond the "Absolute Maximum Ratings" may cause permanent				
damage. These are stress ratings only. Operation beyond the "Operating Conditions" is not				
recommended and extend	recommended and extended exposure beyond the "Operating Conditions" may affect device			

VIO IN

VIO OUT

reliability.

Input Pin Voltage

Output Pin Voltage

Table 4 – Digital Core and I/O Voltage (Volatile)

5.9.2. **DC Electrical Characteristics**

5.9.2.1. TX and 1PPS

TXA and 1PPS outputs at TRISTATE until Active VCC is reached. Active VCC min is 1V.

3.6

3.6

These outputs TRISTATE if VCC reaches Ground. Maximum stress voltage on these pins is 4.5V and there is OVT protection.

 $V_{OL} = 0.3 V - 0.4 V MAX.$ $V_{OH} = 0.75 \text{ x VCC}$ typical MIN, 3.6V MAX pull up. Typical MAX current = +12mA, -12mA. Normal current = +100uA to +6mA (V_{OL}), -100uA to -6mA (V_{OH}) VCC = 2.85V to 3.3V typical, 3.6V MAX.

5.9.2.2. RX

 $V_{IL} = 0.45 V MAX.$

 $V_{IH} = 1.26V$ MIN. MAX 3.6V pull up.

Internal pull up resistance 90k ohm nominal to internal 1.8V. MAX 3.6V pull up.

INPUT/TRISTATE leakage = -10uA, +10uA.

5.9.2.3. SDA2 and SCL2

SDA2 and SCL2 outputs are in a high-impedance state until Active VCC is reached. $V_{OL} = 0.55V \text{ MAX}.$ $V_{OH} = 2.4 V MIN.$





5.9.2.4. BOOT (Flash only)

For normal operation, leave this pin floating. To place the JN3 into BOOT mode, tie this pin to 1.8 volts DC.

Note: This pin is not 3.3 volt tolerant. See the Designer's Notes for more information.

5.9.3. Pinout Description

Details of the LGA pad functions are shown in Table 5.

Pad Number	Pad Function	Туре	Description
1	NC	-	No connection
2	NC	-	No connection
3	1PPS	0	Timemark Pulse, 200ms Active High
4	EXT_INT	Ι	Reserved
5	NC	-	No connection
6	NC	-	No connection
7	BOOT / NC	I/-	Low for run, high for reprogram (Flash only). No connection for ROM devices.
8	NC	-	No connection
9	VCC_IN	PWR	VCC
10	GND	PWR	Ground
11	RF_IN	Ι	GPS RF Input, 50 Ohm
12	GND	PWR	Ground
13	GND	PWR	Ground
14	NC	-	No connection
15	NC	-	No connection
16	NC	-	No connection
17	NC	-	No connection
18	SDA2	I/O	Sensor I2C Data Port
19	SCL2	I/O	Sensor I2C Clock Port
20	ТХ	0	UART TX Output
21	RX	Ι	UART RX Input
22	VBATT	PWR	Battery Backup Voltage
23	VCC_IN	PWR	Main Supply Voltage
24	GND	PWR	Ground

Table 5 – LGA Pad Functions



Reproduction forbidden without written authorization from Telit Communications S.p.A. - All Rights Reserved. Mod. 0808 2011-07 Rev.2 Page 26 of 38



6. Software Interface

The host serial I/O port of the receiver's serial data interface supports full duplex communication between the receiver and the user.

The default serial configuration is as follows: NMEA, 4800 bps, 8 data bits, no parity, 1 stop bit

Note: Contact your local sales representative for details on module configurations with default NMEA 9600 bps.

6.1. NMEA Output Messages

NMEA v3.0 is the default protocol. The following messages are output by default:

- RMC = 1 second update
- GGA = 1 second update
- GSA = 1 second update
- GSV = 5 second update

Reference the NMEA protocol manual for additional message details.

6.2. SiRF OSP Output Messages

SiRF One Socket Protocol (OSP) is supported. This is an extension of the existing SiRF Binary protocol.

The following messages are output once per second:

- MID2
- MID4
- MID9
- MID41
- MID56, 5
- MID56, 35

Reference the SiRF One Socket Protocol manual for additional message details.



Page 27 of 38



6.3. Software Functions and Capabilities

Table 6 shows the software features available to the JN3.

Feature	Description	Availability
SBAS	Improve position accuracy by using freely available satellite based correction services called SBAS (Satellite Based Augmentation System)	А
Adaptive Trickle Power	tive Trickle Power Improves battery life by using enhanced power management and intelligently switching between low and full power depending on the current GPS signal level. Refer to the Low Power Operating Modes application note.	
Almanac to Flash	Improves cold start times by storing the most recent almanac to	Yes
Annanae to Flash	flash memory.	(Flash only)
Low Signal Acquisition	Acquires satellites and continues tracking in extremely low signal environments.	Yes
Low Signal Navigation	Continues navigating in extremely low signal environments.	Yes
Time Mark Pulse (1PPS)A timing pulse generated every second the receiver is in a valid navigation state (5 SVs required for initial pulse start-up).		Yes
	3-axis accelerometer support for static detection.	
MEMS	3-axis magnetometer support for compass heading pass-thru data.	А
Antenna Supervisor Active antenna short circuit and open circuit detection/control, software supported.		V4.1.2
SGEE	AGPS using predicted ephemeris data from a server. Supporting	Yes
SULE	Host required.	(Flash only)
	AGPS using prediction of ephemeris from live (downloaded	Yes
CGEE	from satellites), ephemeris stored in memory.	(Flash/EEPROM only)
Adaptive Jammer Detection		
Yes =	= always enabled $A =$ available, but not enabled by default	

Table 6 – Software Features



Reproduction forbidden without written authorization from Telit Communications S.p.A. - All Rights Reserved. Mod. 0808 2011-07 Rev.2



Mechanical Drawing 7.

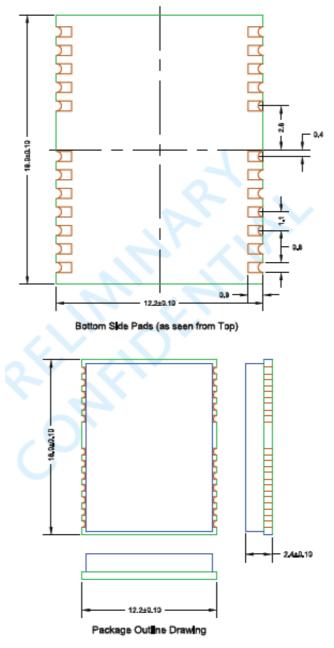


Figure 2 – Mechanical Layout



Reproduction forbidden without written authorization from Telit Communications S.p.A. - All Rights Reserved. Mod. 0808 2011-07 Rev.2

No connection

_



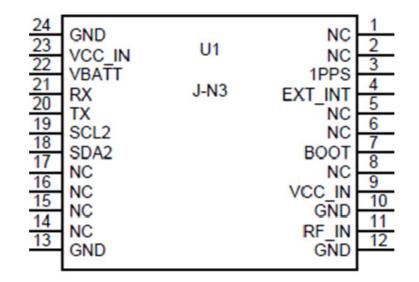


Figure 3 – Pinout (Top View)

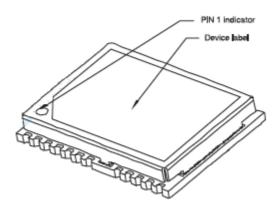


Figure 4 – 3D Model



Page 30 of 38



8. Evaluation Kit

The JN3 Development Kit is available to assist in the evaluation and integration of the JN3 module in custom applications. The Development Kit contains all of the necessary hardware and software to carry out a thorough evaluation of the JN3 module.





9. **Product Handling**

9.1. Product Packaging and Delivery

JN3 modules are shipped in Tape and Reel form. The reeled modules are shipped in 24mm reels with 1000 units per reel. Each reel is 'dry' packaged and vacuum sealed in an Moisture Barrier Bag (MBB) with two silica gel packs and placed in a carton.

The minimum order quantity for shipping is 1000 units. Refer to the Designer's Notes for additional details.

All packaging is ESD protective lined. The JN3 GPS receiver is a Moisture Sensitive Device (MSD) level 3. Please follow the MSD and ESD handling instructions on the labels of the MBB and exterior carton (refer to sections 8.2 and 8.3).

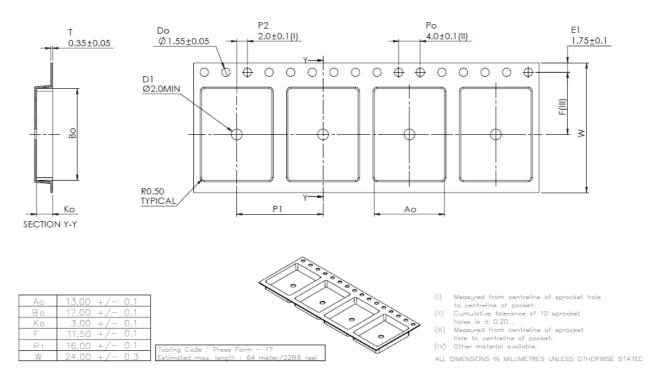


Figure 5 – Tape and Reel Packaging



Reproduction forbidden without written authorization from Telit Communications S.p.A. - All Rights Reserved. Mod. 0808 2011-07 Rev.2 Page 32 of 38



9.2. Moisture Sensitivity

Precautionary measures are required in handling, storing and using such devices to avoid damage from moisture absorption. If localized heating is required to rework or repair the device, precautionary methods are required to avoid exposure to solder reflow temperatures that can result in performance degradation.

Further information can be obtained from the IPC/JEDEC standard J-STD-033: Handling, Packing, Shipping and Use of Moisture/Reflow Sensitive Surface Mount Devices.

9.3. ESD Sensitivity

The JN3 GPS receiver contains class 1 devices and is Electro-Static Discharge Sensitive (ESDS). Telit recommends the two basic principles of protecting ESD devices from damage:

Only handle sensitive components in an ESD Protected Area (EPA) under protected and controlled conditions

Protect sensitive devices outside the EPA using ESD protective packaging. All personnel handling ESDS devices have the responsibility to be aware of the ESD threat to the reliability of electronic products.

Further information can be obtained from the JESD625-A requirements for Handling Electrostatic Discharge Sensitive (ESDS) Devices.

9.4. Safety

Improper handling and use of the Jupiter GPS receiver can cause permanent damage to the receiver. There is also the possible risk of personal injury from mechanical trauma or choking hazard.

9.5. Disposal

We recommend that this product should not be treated as household waste. For more detailed information about recycling this product, please contact your local waste management authority

or the reseller from whom you purchased the product.



Page 33 of 38



10. Ordering Information

- JN3.B3A2.Lx JN3 Flash Module
- JN3.B3EV.L JN3 Flash Module Evaluation Kit
- JN3.C1A4.Dx JN3 512K EEPROM Module
- JN3.C1EV.D JN3 512K EEPROM Evaluation Kit
- JN3.C0A0.Dx JN3 ROM Module
- JN3.C0EV.D JN3 ROM Evaluation Kit

NOTE: x denotes packaging type (R=Tape & Reel, Y=Tray, B=Tube, S=Samples). Contact your local sales representative for more details.



Page 34 of 38



11. Glossary and Acronyms

AGPS: Assisted GPS. AGPS uses additional resources to locate the satellites faster and better in poor signal conditions.

Almanac: A set of orbital parameters that allows calculation of approximate GPS satellite positions and velocities. The almanac is used by a GPS receiver to determine satellite visibility and as an aid during acquisition of GPS satellite signals. The almanac is a subset of satellite ephemeris data and is updated weekly by GPS Control.

CGEE: Client Generated Extended Ephemeris data. AGPS using prediction of ephemeris from live (downloaded from satellites), ephemeris stored in memory.

EGNOS: European Geostationary Navigation Overlay Service

The system of geostationary satellites and ground stations developed in Europe to improve the position and time calculation performed by the GPS receiver.

Ephemeris plural ephemerides: A set of satellite orbital parameters that is used by a GPS receiver to calculate precise GPS satellite positions and velocities. The ephemeris is used to determine the navigation solution and is updated frequently to maintain the accuracy of GPS receivers.

ESD: Electro-Static Discharge

large momentary unwanted currents that cause damage to electronic equipment.

GDOP: Geometric Dilution of Precision.

A factor used to describe the effect of the satellite geometry on the position and time accuracy of the GPS receiver solution. The lower the value of the GDOP parameter, the less the error in the position solution. Related indicators include PDOP, HDOP, TDOP and VDOP.

GPS: Global Positioning System.

A space-based radio positioning system that provides accurate position, velocity, and time data.

InstantFix: Eliminates the initial delay of obtaining GPS satellite location data from the satellites themselves by using algorithms to predict seven days of satellite location data.

LGA: Land Grid Array.

There are no pins on the chip; in place of the pins are pads of bare gold-plated copper that touch pins on the motherboard.

MSD: Moisture sensitive device.

NMEA: National Marine Electronics Association

POR: Power on Reset.

SBAS: Satellite Based Augmentation System

Any system that uses a network of geostationary satellites and ground stations to improve the performance of a Global Navigation Satellite System (GNSS). Current examples are EGNOS and WAAS.



Page 35 of 38



SGEE: Server Generated Extended Ephemeris data. AGPS using predicted ephemeris data from a server. Supporting Host required.

WAAS: Wide Area Augmentation System

The system of satellites and ground stations developed by the FAA (Federal Aviation Administration) that provides GPS signal corrections. WAAS satellite coverage is currently only available in North America.



Page 36 of 38



12. Safety Recommendations

READ CAREFULLY

Be sure the use of this product is allowed in the country and in the environment required. The use of this product may be dangerous and has to be avoided in the following areas:

- Where it can interfere with other electronic devices in environments such as hospitals, airports, aircrafts, etc.
- Where there is risk of explosion such as gasoline stations, oil refineries, etc. It is responsibility of the user to enforce the country regulation and the specific environment regulation.

Do not disassemble the product; any mark of tampering will compromise the warranty validity. We recommend following the instructions of the hardware user guides for a correct wiring of the product. The product has to be supplied with a stabilized voltage source and the wiring has to be conforming to the security and fire prevention regulations. The product has to be handled with care, avoiding any contact with the pins because electrostatic discharges may damage the product itself. Same cautions have to be taken for the SIM, checking carefully the instruction for its use. Do not insert or remove the SIM when the product is in power saving mode.

The system integrator is responsible of the functioning of the final product; therefore, care has to be taken to the external components of the module, as well as of any project or installation issue, because the risk of disturbing the GSM network or external devices or having impact on the security. Should there be any doubt, please refer to the technical documentation and the regulations in force. Every module has to be equipped with a proper antenna with specific characteristics. The antenna has

to be installed with care in order to avoid any interference with other electronic devices and has to guarantee a minimum distance from the body (20 cm). In case of this requirement cannot be satisfied, the system integrator has to assess the final product against the SAR regulation.

The European Community provides some Directives for the electronic equipments introduced on the market. All the relevant information's are available on the European Community website:

http://ec.europa.eu/enterprise/sectors/rtte/documents/

The text of the Directive 99/05 regarding telecommunication equipments is available, while the applicable Directives (Low Voltage and EMC) are available at:

http://ec.europa.eu/enterprise/sectors/electrical/



Reproduction forbidden without written authorization from Telit Communications S.p.A. - All Rights Reserved. Mod. 0808 2011-07 Rev.2



13. Document History

Revision	Date	Changes
0		First issue



Reproduction forbidden without written authorization from Telit Communications S.p.A. - All Rights Reserved. Mod. 0808 2011-07 Rev.2 Page 38 of 38